

Features

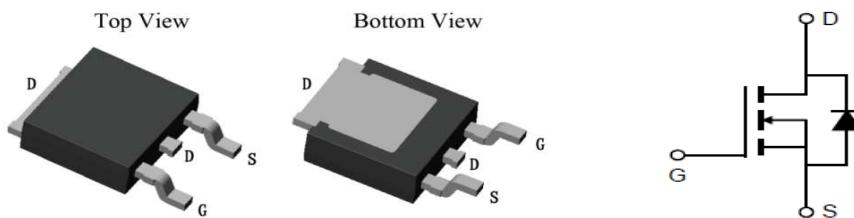
- CRM(CQ) Super_Junction technology
- Much lower Ron*A performance for On-state efficiency
- Better efficiency due to very low FOM

Product Summary

VDS	650V
R _{DS(on)} _typ	0.42Ω
I _D	8A

Applications

- LED/LCD/PDP TV and monitor Lighting
- Solar/Renewable/UPS-Micro Inverter System
- Charger
- Power Supply

100% Avalanche Tested

Package Marking and Ordering Information

Part #	Marking	Package	Packing	Reel Size	Tape Width	Qty
CRJD550N65G2	-	TO-252	Tape&Reel	N/A	N/A	2500pcs

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source voltage	V _{DS}	650	V
Continuous drain current $T_C = 25^\circ\text{C}$	I _D	8	A
$T_C = 100^\circ\text{C}$		5	
Pulsed drain current ($T_C = 25^\circ\text{C}$, t_p limited by $T_{j\max}$)	I _D pulse	32	A
Avalanche energy, single pulse ($L=30\text{mH}$, $R_g=30\Omega$)	E _{AS}	65	mJ
Gate-Source voltage	V _{GS}	± 30	V
Power dissipation ($T_C = 25^\circ\text{C}$)	P _{tot}	73	W
Operating junction and storage temperature	T _j , T _{stg}	-55...+150	°C

Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal resistance, junction – case. Max	R _{thJC}	1.70	°C/W
Thermal resistance, junction – ambient. Max	R _{thJA}	143	

Electrical Characteristic (at T_j = 25 °C, unless otherwise specified)

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		

Static Characteristic

Drain-source breakdown voltage	BV _{DSS}	650	-	-	V	V _{GS} =0V, I _D =250uA
Gate threshold voltage	V _{GS(th)}	3	-	4	V	V _{DS} =V _{GS} , I _D =250uA
Zero gate voltage drain current	I _{DSS}	-	-	1	μA	V _{DS} =650V, V _{GS} =0V T _C =25°C T _C =150°C
Gate-source leakage current	I _{GSS}	-	0.5	100	nA	V _{GS} =±30V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.42	0.55	Ω	V _{GS} =10V, I _D =4A, T _C =25°C T _C =150°C
Transconductance	g _{fs}	-	6.6	-	S	V _{DS} =20V, I _D =4A

Dynamic Characteristic

Input Capacitance	C _{iss}	-	470	-	pF	V _{GS} =0V, V _{DS} =100V, f=1MHz
Output Capacitance	C _{oss}	-	25	-		
Reverse Transfer Capacitance	C _{rss}	-	0.47	-		
Gate Total Charge	Q _G	-	15.6	-	nC	V _{GS} =10V, V _{DS} =480V, I _D =4A
Gate-Source charge	Q _{gs}	-	3.1	-		
Gate-Drain charge	Q _{gd}	-	6.5	-		
Turn-on delay time	t _{d(on)}	-	15	-	ns	T _j =25°C, V _{GS} =10V, I _D =4A, V _{DS} =400V, R _g =27Ω
Rise time	t _r	-	17	-		
Turn-off delay time	t _{d(off)}	-	78	-		
Fall time	t _f	-	16	-		
Gate resistance	R _{gint}	-	14	-	Ω	f=1MHz



华润微电子(重庆)有限公司

CRJD550N65G2

SJMOS N-MOSFET 650V, 0.42Ω, 8A

Body Diode Characteristic

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Body Diode Forward Voltage	V_{SD}	0.6	0.85	1.1	V	$V_{GS}=0V, I_{SD}=4A$
Body Diode Reverse Recovery Time	t_{rr}	-	210	-	ns	$I_{sd}=4A$ $dI/dt=100A/\mu s$ $V_{ds}=400V$
Body Diode Reverse Recovery Charge	Q_{rr}	-	1.76	-	μC	

Typical Performance Characteristics

Fig 1. Output Characteristics ($T_j=25^\circ\text{C}$)

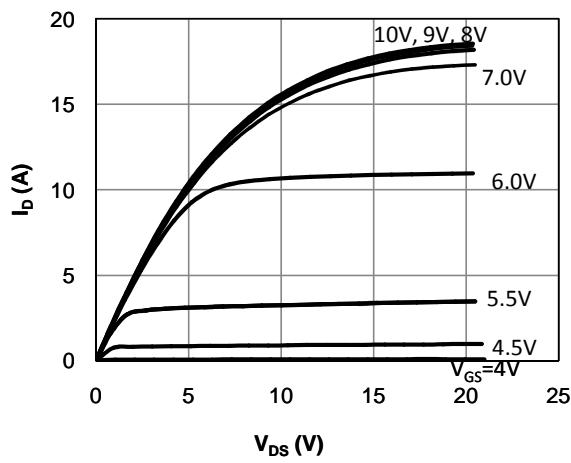


Fig 2. Output Characteristics ($T_j=150^\circ\text{C}$)

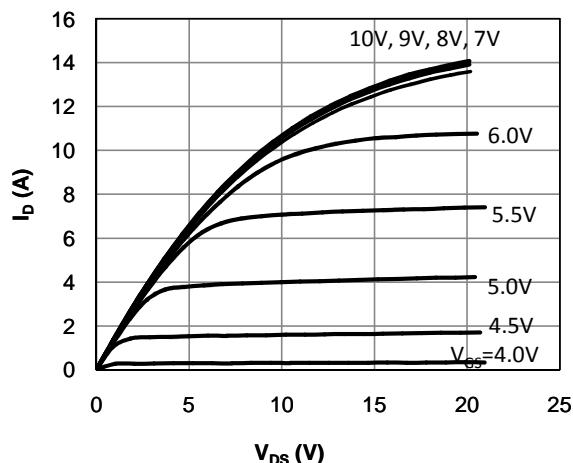


Fig 3: Transfer Characteristics

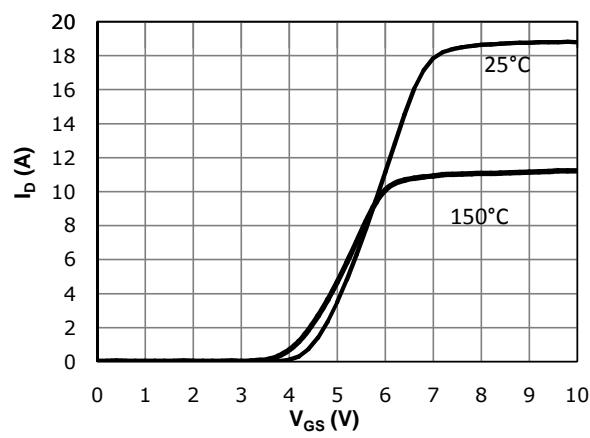


Fig 4: V_{TH} Vs T_j Temperature Characteristics

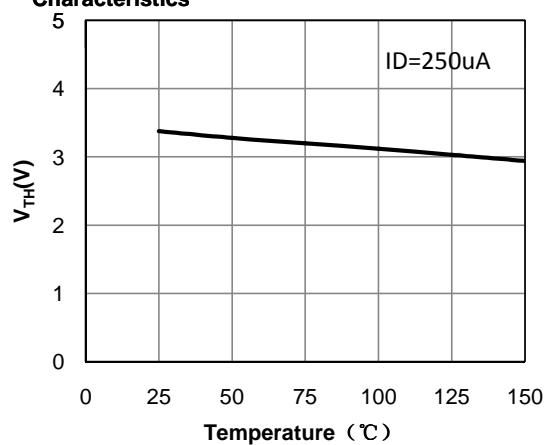


Fig 5: $R_{DS(on)}$ Vs I_{DS} Characteristics($T_c=25^\circ\text{C}$)

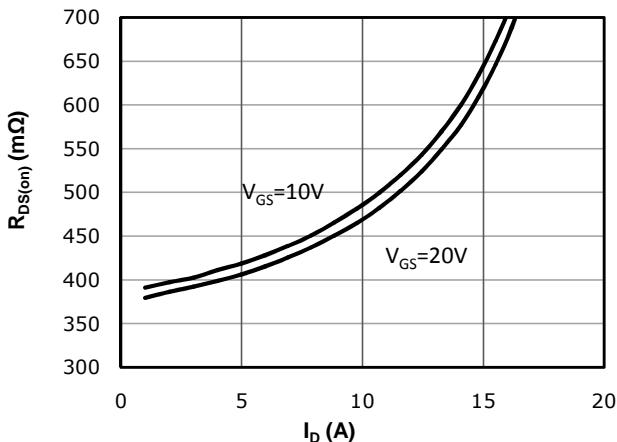


Fig 6: $R_{DS(on)}$ vs. Temperature

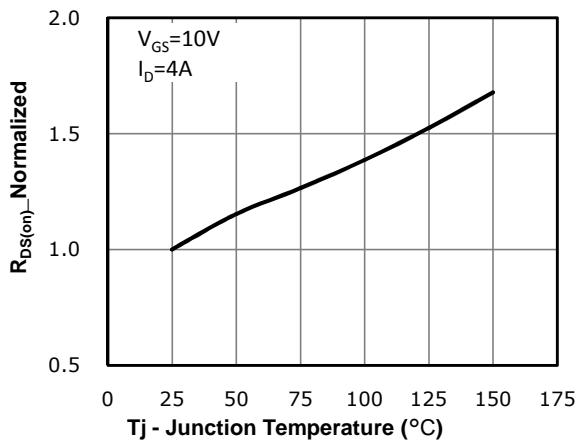


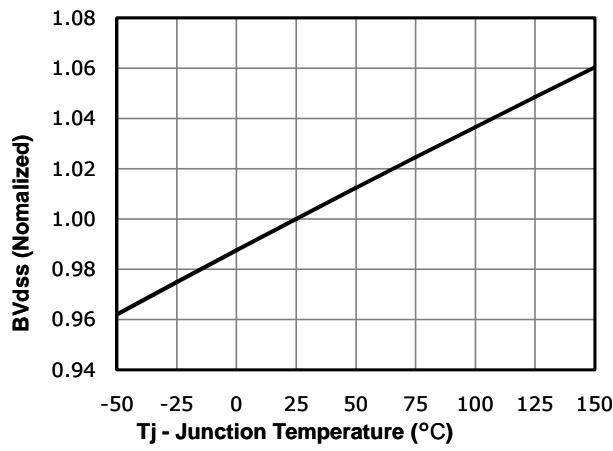
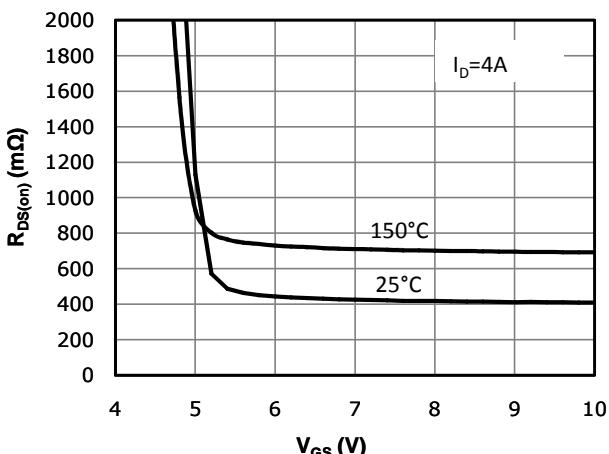
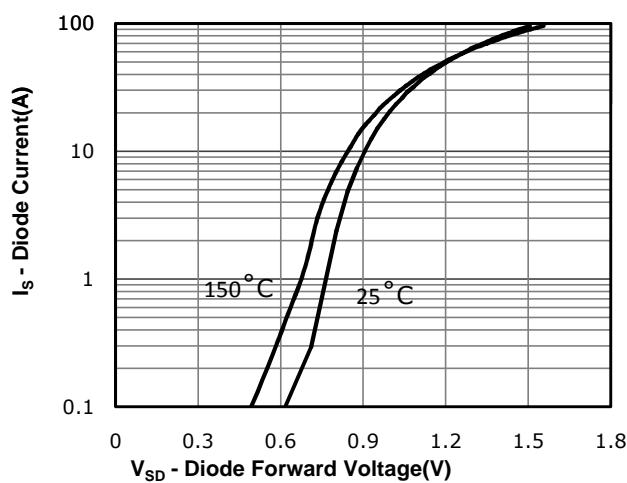
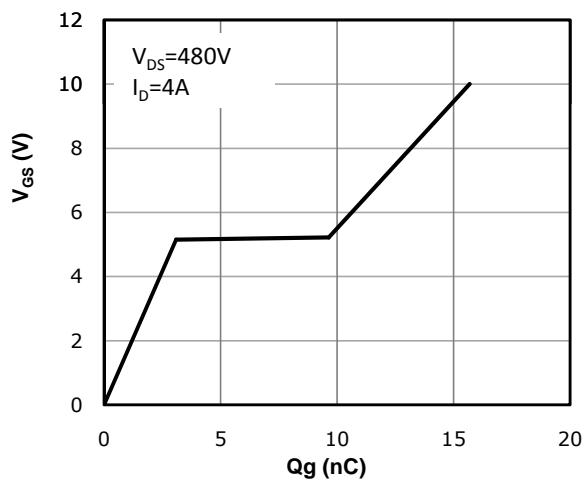
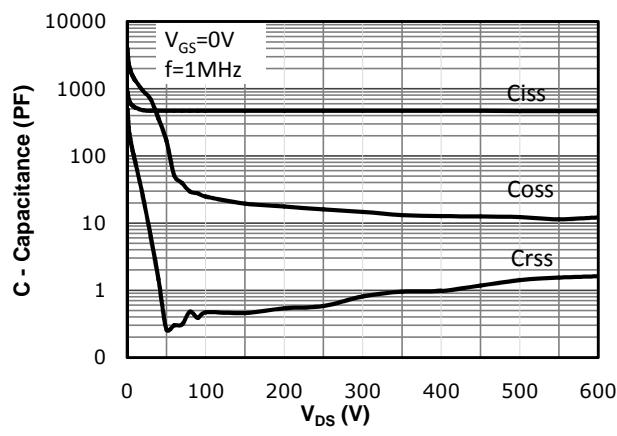
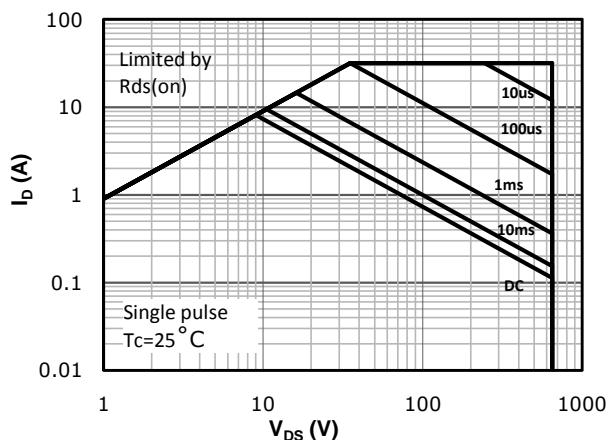
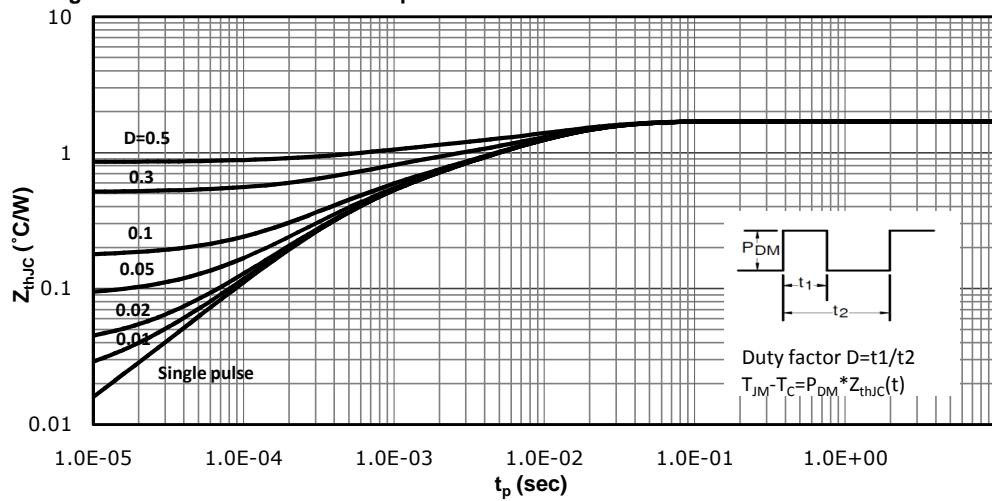
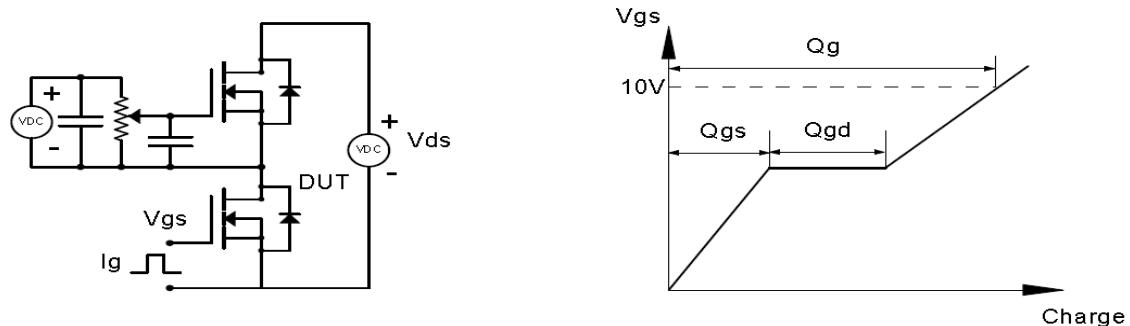
Fig 7: BV_{DSS} vs. Temperature

Fig 8: R_{d(on)} vs Gate Voltage

Fig 9: Body-diode Forward Characteristics

Fig 10: Gate Charge Characteristics

Fig 11: Capacitance Characteristics

Fig 12: Safe Operating Area


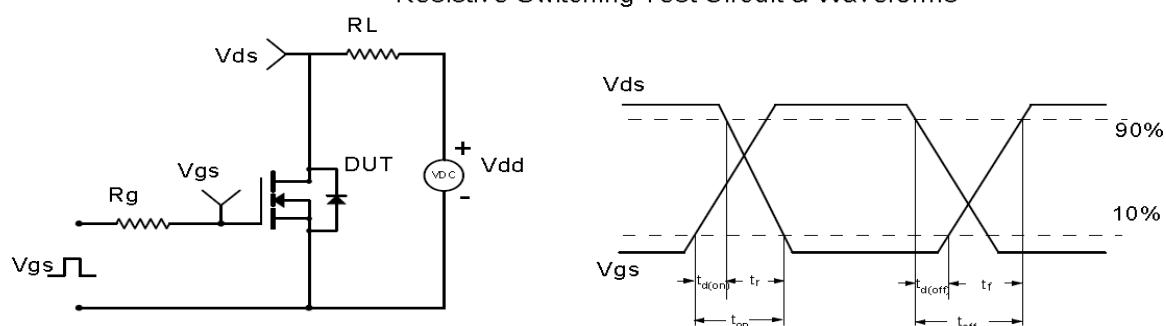
Fig 13: Max. Transient Thermal Impedance

Test Circuit & Waveform

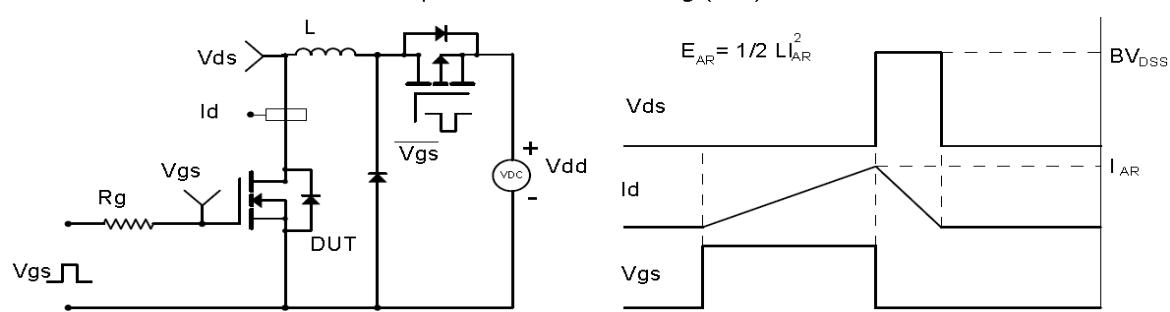
Gate Charge Test Circuit & Waveform



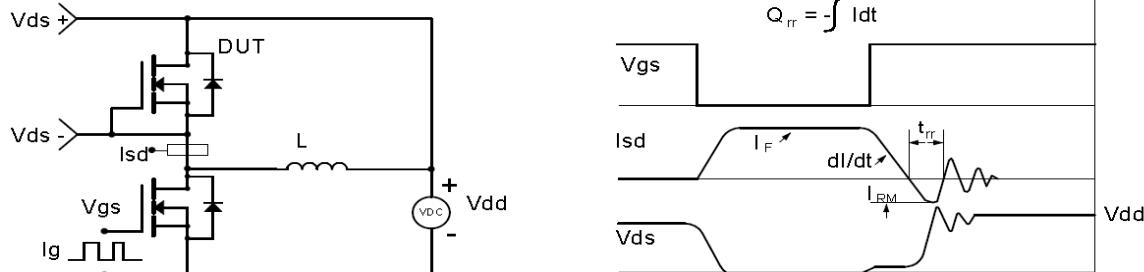
Resistive Switching Test Circuit & Waveforms

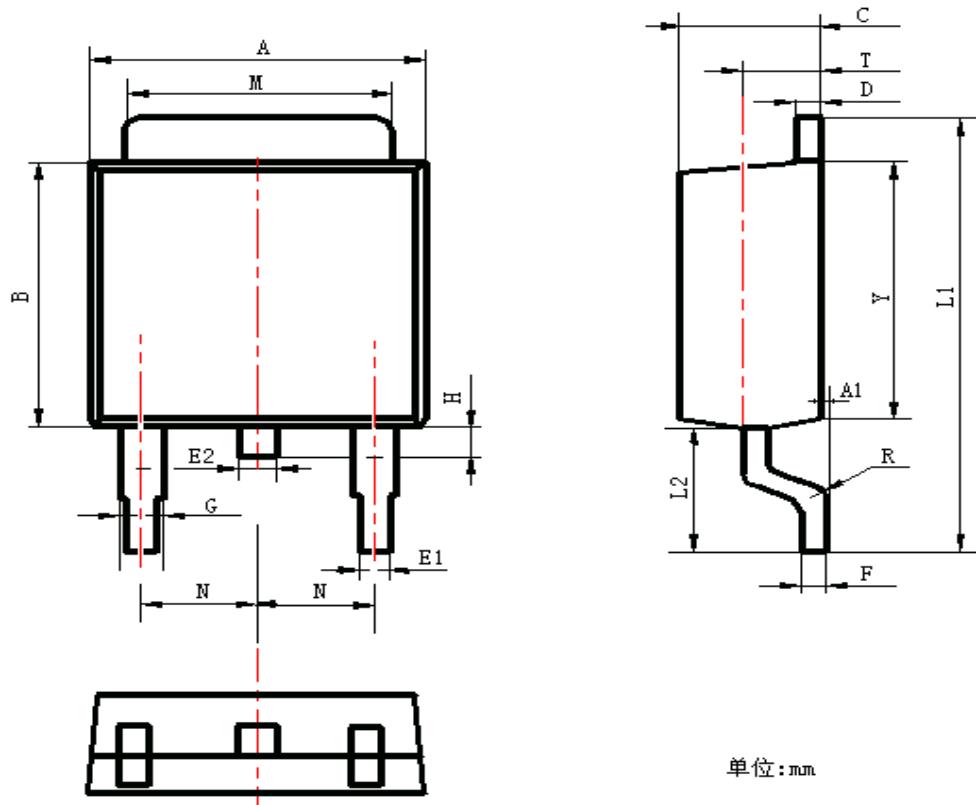


Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms



Package Outline: TO-252


单位:mm

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	6.30	6.90	0.248	0.272
A1	0.00	0.16	0.000	0.006
B	5.70	6.30	0.224	0.248
C	2.10	2.50	0.083	0.098
D	0.30	0.70	0.012	0.028
E1	0.60	0.90	0.024	0.035
E2	0.70	1.00	0.028	0.039
F	0.30	0.60	0.012	0.024
G	0.70	1.20	0.028	0.047
L1	9.60	10.50	0.378	0.413
L2	2.70	3.10	0.106	0.122
H	0.40	1.00	0.016	0.039
M	5.10	5.50	0.201	0.217
N	2.09	2.49	0.082	0.098
R	0.30		0.012	
T	1.40	1.60	0.055	0.063
Y	5.10	6.30	0.201	0.248



华润微电子(重庆)有限公司

CRJD550N65G2

SJMOS N-MOSFET 650V, 0.42Ω, 8A

Revision History

Revison	Date	Major changes
1.0	2021-4-9	Release of first version

Disclaimer

Unless otherwise specified in the datasheet, the product is designed and qualified as a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability, such as automotive, aviation/aerospace and life-support devices or systems.

Any and all semiconductor products have certain probability to fail or malfunction, which may result in personal injury, death or property damage. Customer are solely responsible for providing adequate safe measures when design their systems.

CRM(CQ) reserves the right to improve product design, function and reliability without notice.